

MT29F16G08ABCBBM62B3WC1 Information


For Reference Only

Part Number [MT29F16G08ABCBBM62B3WC1](#)
Manufacturer Micron Technology Inc.

Category Integrated Circuits (ICs)
[Memory](#)
Description IC FLASH 16G PARALLEL DIE

Package -

For the pricing/inventory/lead time, please contact us

 Website: <https://www.heisener.com>

 E-mail: salesdept@heisener.com

[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


MT29F16G08ABCBBM62B3WC1 Specifications

Manufacturer Part Number	MT29F16G08ABCBBM62B3WC1
Manufacturer	Micron Technology Inc.
Category	Integrated Circuits (ICs) Memory
Package	-
Series	-
Memory Type	Non-Volatile
Memory Format	FLASH
Technology	FLASH - NAND
Memory Size	16Gb (2G x 8)
Memory Interface	Parallel
Clock Frequency	-
Write Cycle Time - Word, Page	-
Access Time	-
Voltage - Supply	2.7V ~ 3.6V
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	-
Supplier Device Package	-

[Report errors?](#)

MT29F16G08ABCBBM62B3WC1 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

MT29F16G08ABCBBM62B3WC1 Payment Methods



MT29F16G08ABCBBM62B3WC1 Shipping Methods



If you have any question about MT29F16G08ABCBBM62B3WC1, please do not hesitate to contact us!

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